# **DESIGN OF MICROSTRUCTURES USING STRESS-BASED**

### **TOPOLOGY OPTIMIZATION**

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# MOTIVATION

Microstructural design (MD) using topology optimization along with homogenization to compute equivalent elastic properties is used to conceive optimal microstructures addressing specific needs:





# EXAMPLE 2: Bronzi di Riace SEISMIC INSULATOR

• *Bronzi di Riace* statue with its marble seismic insulator:



Currently: Four marble balls used to isolate the statues in case of earthquakes. Design requirements are high bulk and low shear (under pre-



 $\max \mathcal{K} \text{ s.t. } V \leq 0, 5: \mathcal{K}_{optimized} = 0,6734$ 

Accounting for the stress level within the optimized layouts ensures the structural integrity of the microstructure.

#### **SENSITIVITY ANALYSIS OF THE STRESSES**

Sensitivity along with the qp-relaxation (Bruggi,2008)<sup>*a*</sup>:

$$\frac{\partial \sigma_{VM,e}}{\partial x_k} = \delta_{ek}(p-q)x_e^{p-q-1} \,\overline{\sigma}_{VM,e} + \frac{\partial \overline{\sigma}_{VM,e}}{\partial x_k}x_e^{p-q}$$

Adjoint approach (active set :  $N_a$  selected constraints < N total constraints)

$$\frac{\partial \overline{\sigma}_{VM,e}}{\partial x_k} = \lambda^T \frac{\partial \mathbf{K}}{\partial x_k} \mathbf{u} - \lambda^T \left( p x_k^{p-1} f_{e,0}^i \right)$$

with the adjoint problem and force vector:

$$\mathbf{K}\lambda = -\left[\left(\mathbf{u}_{\mathbf{e}}^{\mathbf{T}}\mathbf{M}_{\mathbf{e}}^{\mathbf{0}}\mathbf{u}_{\mathbf{e}}\right)^{-1/2}\mathbf{M}_{\mathbf{e}}^{\mathbf{0}}\mathbf{u}_{\mathbf{e}}\right]^{\mathbf{T}}$$
$$f_{e,0}^{i} = \sum_{i=1}^{n1}\sum_{j=1}^{n2}w_{i}w_{j}\mathbf{B}_{\mathbf{e}}^{T}\mathbf{H}_{\mathbf{e}}^{\mathbf{0}}\varepsilon_{0}^{i}detJ$$

scribed value). A topology optimization can be formulated:

$$\max_{0 < x_{\min} \le x_e \le 1} \mathcal{K}$$
s.t.  $\mathbf{K}(\mathbf{x})\mathbf{u}^i = \mathbf{f}(\mathbf{x})^i; \quad i = 1, 2$ 

$$\mathcal{G} \le \mathcal{G}^*$$
 $(\langle \sigma_{VM,e}(x) \rangle \le \sigma_y^0)$ 
• Two load cases !
• Starting point: Hole with void at the center of the RVE
•  $\sigma_y^0 = 1.8N/m^2$  and  $\mathcal{G} \le 10^{-3}N/m^2$ 

• <u>No</u> stress constraints :  $\mathcal{K}_{optimized} = 0,3665$ 

<sup>*a*</sup>Bruggi M (2008) On an alternative approach to stress constraints relaxation in topology optimization. Struct Multidisc Optim 36:125-141

# EXAMPLE 1: CLASSICAL BULK MAXIMIZATION

The maximization of the bulk modulus under stress constraints with  $\sigma_y^0 = 1, 4N/m^2$ 





 $\max \mathcal{K} \text{ s.t. } V \leq 0.5 \text{ AND } \sigma \leq \sigma_y^0: \mathcal{K}_{optimized} = 0,6719$ 

• Similar topology compared to the classical solution but with a controlled stress level ( $\frac{\sigma}{\sigma} < 1$ )





• <u>With</u> stress constraints :  $\mathcal{K}_{optimized} = 0,4376$ 





• Control of the local stress constraints  $(\frac{\sigma}{\sigma_y^0} \le 1)$ 

#### controlled stress level $\left(\frac{\sigma}{\sigma_{y}^{0}} \leq 1\right)$

- More square shaped compared to the classical solution
- Lower optimized bulk modulus

#### • Change in the topology of the optimized layouts

• Existence of local optima !

## **CONCLUSION AND PERSPECTIVES**

- Control of the stress level introduced in a topology optimization framework for microstructural design (sensitivity analysis)
- The optimization might be steered toward better optimum  $\implies$  Presence of local minima
- Speed up the computation ! CPU requirement is still to high !
- Extension to 3D manufacturable microstructures

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